

**TEMASEK INFORMATICS & IT SCHOOL
STUDENT INTERNSHIP PROGRAMME PLEDGE FORM**

I, _____ Admission No _____ Class _____

agree to be attached to :

(Name of Company)

I understand that the company, in accepting me for the Student Internship Programme, is doing a service to Temasek Polytechnic. I am fully aware that failure to comply with the terms and conditions of the attachment will result in disciplinary action taken against me.

I therefore promise that I will:

1. Complete my in-company training/attachment;
2. Fulfill all responsibilities entrusted to me with care and diligence;
3. Observe all rules and regulations specified by the Company and Temasek Polytechnic;
4. Keep in confidence information relating to the Company;
5. Be present on all working days (as required by both the Company Supervisor and the Liaison Officer);
6. Be punctual at work;
7. Always be on my best behaviour to maintain and enhance the good name of Temasek Polytechnic;
8. Not infringe any patent, copyright, trade secret, design right or other proprietary rights of whatever nature belonging to any third party. [An example of an infringement of such rights includes but is not limited to illegal copying or downloading];

I also promise to keep a daily/weekly summary of tasks in my student e-log system and will submit a final report to my Liaison Officer upon completion of my attachment.

Signature

Date

Witnessed by:

Name of Liaison Officer

Signature

Date